



IN THE

UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANTS: Steven F. Reiber et al.  
SERIAL NO.: 09/514,454  
FILING DATE: February 25, 2000  
TITLE: Dissipative Ceramic Bonding Tip  
GROUP ART UNIT: 1725  
ATTY.DKT.NO.: PA1118US

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**CERTIFICATE OF MAILING**

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Date: October 5, 2000



David Lewis

ASSISTANT COMMISSIONER FOR PATENTS  
WASHINGTON, D.C. 20231

**PRELIMINARY AMENDMENT**

Sir,

Please amend the above-identified Application as follows:

In the claims

In claim 1, line 6 replace "damaging" with - - damage - -.

In claim 9, line 1, replace "conductor" with - - conducting core - -.

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